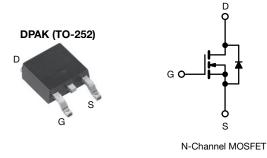
SiHD690N60E

Vishay Siliconix



E Series Power MOSFET



PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	650				
R _{DS(on)} typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.60			
Q _g max. (nC)	12				
Q _{gs} (nC)	3				
Q _{gd} (nC)	3				
Configuration	Single				

FEATURES

- 4th generation E series technology
- Low figure-of-merit (FOM) Ron x Qg
- Low effective capacitance (C_{o(er)})
- Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Solar (PV inverters)

ORDERING INFORMATION				
Package	DPAK (TO-252)			
Lead (Pb)-free and halogen-free	SiHD690N60E-GE3			

PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			V _{DS}	600	v
Gate-source voltage			V _{GS}	± 30	v
Continuous drain current (T _J = 150 °C)	V _{GS} at 10 V	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$ $T_{\rm C} = 100 \ ^{\circ}{\rm C}$	Ι _D	6.4	А
	VGS at 10 V	T _C = 100 °C		4.0	
Pulsed drain current ^a			I _{DM}	11	
Linear derating factor				0.5	W/°C
Single pulse avalanche energy ^b			E _{AS}	9	mJ
Maximum power dissipation			PD	62.5	W
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C
Drain-source voltage slope $T_J = 125 \text{ °C}$		alı . / alt	70		
Reverse diode dv/dt d			dv/dt -	17	V/ns
Soldering recommendations (peak temperature)	С	For 10 s		260	°C

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b. V_{DD} = 120 V, starting T_J = 25 °C, L = 28.2 mH, R_q = 25 Ω , I_{AS} = 0.8 A

c. 1.6 mm from case

d. $I_{SD} \leq I_D, \, di/dt$ = 100 A/µs, starting T_J = 25 $^\circ C$



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SHAY

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THERMAL RESISTANCE RATINGS								
PARAMETER	SYMBOL	TYP.		MAX.			UNIT	
Maximum junction-to-ambient	R _{thJA}	- 62			°C AN			
Maximum junction-to-case (drain)	R _{thJC}	- 2.0			°C/W			
SPECIFICATIONS (T _J = 25 $^{\circ}$ C, t	unless otherwi	se noted)						
PARAMETER	SYMBOL	TES	T CONDIT	IONS	MIN.	TYP.	MAX.	UNIT
Static								
Drain-source breakdown voltage	V _{DS}	V _{GS} =	$V_{GS} = 0 V, I_D = 250 \mu A$		600	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_J$	Referenc	e to 25 °C,	I _D = 1 mA	-	0.73	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	· V _{GS} , I _D = 2	250 µA	3.0	-	5.0	V
		, v	√ _{GS} = ± 20	V	-	-	± 100	nA
Gate-source leakage	I _{GSS}	, v	V _{GS} = ± 30	V	-	-	± 1	μA
Zara gata valtaga drain overant		V _{DS} =	600 V, V _G	_S = 0 V	-	-	1	
Zero gate voltage drain current	IDSS	V _{DS} = 480 V	, V _{GS} = 0 V	∕, T _J = 125 °C	-	-	10	μA
Drain-source on-state resistance	R _{DS(on)}	$V_{GS} = 10 V$	١ _c	₀ = 2.0 A	-	0.60	0.70	Ω
Forward transconductance a	9 _{fs}	V _{DS} =	= 20 V, I _D =	= 2.0 A	-	1.2	-	S
Dynamic					•	•	•	•
Input capacitance	C _{iss}	V _{GS} = 0 V,		-	347	-		
Output capacitance	C _{oss}	· ·	$V_{\rm DS} = 0.0$ V, $V_{\rm DS} = 100$ V,		-	24	-	1
Reverse transfer capacitance	C _{rss}	f = 1 MHz		-	4	-		
Effective output capacitance, energy related ^a	C _{o(er)}	$V_{DS} = 0$ V to 480 V, $V_{GS} = 0$ V		-	17	-	pF	
Effective output capacitance, time related ^b	C _{o(tr)}			-	86	-	1	
Total gate charge	Qg				-	8	12	
Gate-source charge	Q _{gs}	V _{GS} = 10 V	$I_{\rm D} = 2.0$	A, V _{DS} = 480 V	-	3	-	nC
Gate-drain charge	Q _{gd}				-	3	-	
Turn-on delay time	t _{d(on)}				-	12	24	
Rise time	t _r	- V _{DD} =	480 V, I _D =	= 2.0 A,	-	9	18	
Turn-off delay time	t _{d(off)}		$V_{GS} = 10 \text{ V}, \text{ R}_{g} = 9.1 \Omega$		-	19	38	ns
Fall time	t _f			-	22	44	1	
Gate input resistance	R _g	f = 1	MHz, oper	n drain	1.1	2.3	4.6	Ω
Drain-Source Body Diode Characterist		•						
Continuous source-drain diode current	۱ _S	MOSFET sym showing the	MOSFET symbol showing the		-	-	6.4	_
Pulsed diode forward current	I _{SM}	integral reverse p - n junction diode		-	-	11	A	
Diode forward voltage	V _{SD}	T _J = 25 °C	, I _S = 2.0 A	A, V _{GS} = 0 V	-	-	1.2	V
Reverse recovery time	t _{rr}				-	146	292	ns
Reverse recovery charge	Q _{rr}	T _J = 25 °C, I _F = I _S = 2.0 A, di/dt = 100 A/µs, V _B = 25 V		-	1.0	2.0	μC	
Reverse recovery current	I _{RRM}	ai/at = 1	100 A/µs, \	/ _R = ∠5 V	-	13	-	A
,				1		I	1	

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}



SiHD690N60E

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

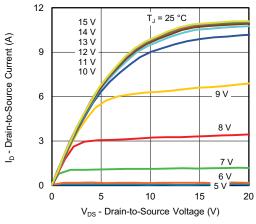


Fig. 1 - Typical Output Characteristics

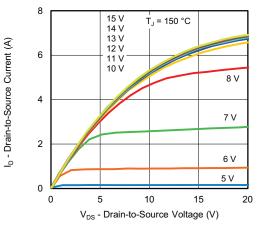


Fig. 2 - Typical Output Characteristics

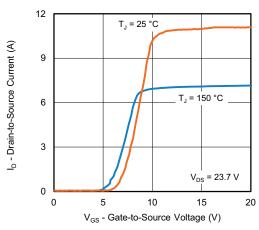


Fig. 3 - Typical Transfer Characteristics

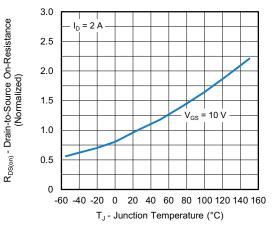


Fig. 4 - Normalized On-Resistance vs. Temperature

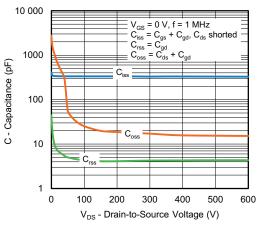


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

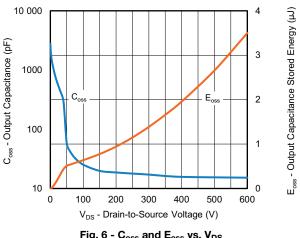


Fig. 6 - Coss and Eoss vs. VDS

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Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

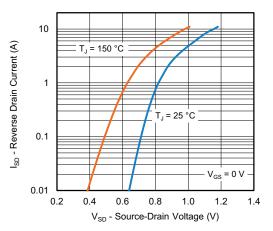


Fig. 8 - Typical Source-Drain Diode Forward Voltage

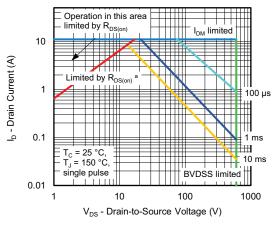


Fig. 9 - Maximum Safe Operating Area

Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

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7

6

5

4

3 2

1

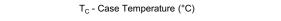
0

25

50

I_D - Drain Current (A)

SiHD690N60E



100

125

150

75

Fig. 10 - Maximum Drain Current vs. Case Temperature

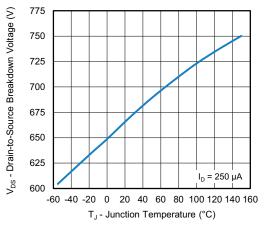


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case

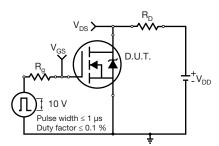


Fig. 13 - Switching Time Test Circuit

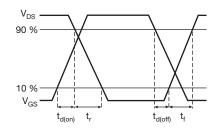


Fig. 14 - Switching Time Waveforms

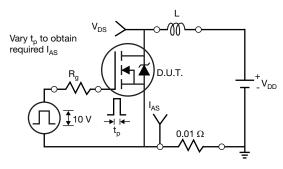


Fig. 15 - Unclamped Inductive Test Circuit

VDD V_{DS} I_{AS}

Fig. 16 - Unclamped Inductive Waveforms

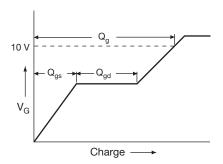


Fig. 17 - Basic Gate Charge Waveform

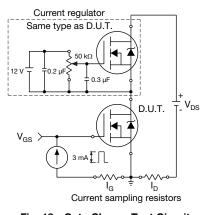


Fig. 18 - Gate Charge Test Circuit

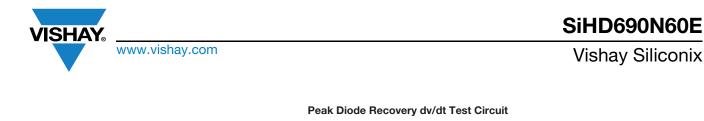
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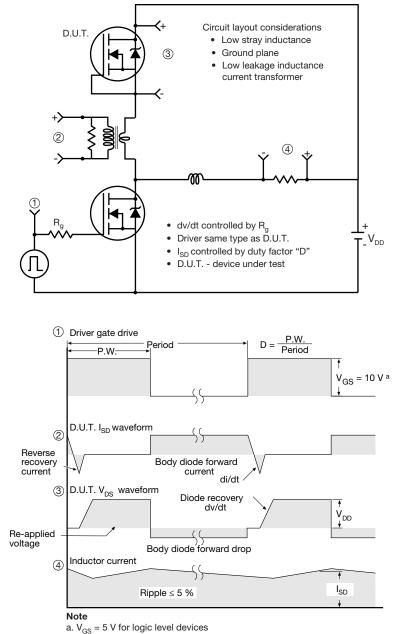


Fig. 19 - For N-Channel

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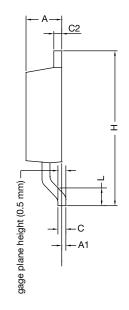


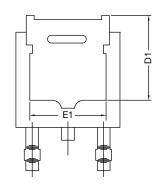


TO-252AA Case Outline

VERSION 1: FACILITY CODE = Y







	MILLIMETERS			
DIM.	MIN.	MAX.		
А	2.18	2.38		
A1	-	0.127		
b	0.64	0.88		
b2	0.76	1.14		
b3	4.95	5.46		
С	0.46	0.61		
C2	0.46	0.89		
D	5.97	6.22		
D1	4.10	-		
E	6.35	6.73		
E1	4.32	-		
Н	9.40	10.41		
е	2.28	2.28 BSC		
e1	4.56	4.56 BSC		
L	1.40	1.78		
L3	0.89	1.27		
L4	-	1.02		
L5	1.01 1.52			

Note

• Dimension L3 is for reference only



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VERSION 2: FACILITY CODE = N



	MILLIMETERS		
DIM.	MIN.	MAX.	
A	2.18	2.39	
A1	-	0.13	
b	0.65	0.89	
b1	0.64	0.79	
b2	0.76	1.13	
b3	4.95	5.46	
С	0.46	0.61	
c1	0.41	0.56	
c2	0.46	0.60	
D	5.97	6.22	
D1	5.21	-	
E	6.35	6.73	
E1	4.32 -		
е	2.29 BSC		
Н	9.94 10.34		

	MILLIMETERS		
DIM.	MIN.	MAX.	
L	1.50	1.78	
L1	2.74 ref.		
L2	0.51 BSC		
L3	0.89	1.27	
L4	-	1.02	
L5	1.14	1.49	
L6	0.65	0.85	
θ	0°	10°	
θ1	0°	15°	
θ2	25° 35°		

Notes

• Dimensioning and tolerance confirm to ASME Y14.5M-1994

• All dimensions are in millimeters. Angles are in degrees

• Heat sink side flash is max. 0.8 mm

Radius on terminal is optional

ECN: E22-0399-Rev. R, 03-Oct-2022 DWG: 5347

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RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

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